

Product Datasheet



$35 \text{mm} \oslash \text{Ultracapacitors}$

- Rated voltage 3VDC
- 330F and 360F capacitance
- Highest power density based on ultra-low ESR
- High cycle life of 1 million cycles
- Hermetically sealed cell
- Most ruggedized cell based on all laser welded design
- Radial terminals for PCB mounting



ELECTRICAL SPECIFICATIONS		
Туре	C35S-3R0-0330	C35S-3R0-0360
Rated Voltage V _R	3.00 V	3.00 V
Surge Voltage V _S ¹	3.10 V	3.10 V
Rated Capacitance C ²	330 F	360 F
Capacitance Tolerance ³	0% / +20%	0% / +20%
ESR ² (DC, 10 Hz)	<1.2 mΩ	<1.8 mΩ
ESR ² (AC, 1 kHz)	<0.9 mΩ	<1.4 mΩ
Leakage Current, typical IL ⁴	<1 mA	<1 mA
Self-discharge Rate, typical ⁵	<20%	<20%
Constant Current ($\Delta T = 15^{\circ}C$) ⁶	33 A	25 A
Max Current I _{Max} ⁷	355 A	329 A
Short Current Is ⁸	2.5 kA	1.5 kA
Stored Energy E ⁹	0.4 Wh	0.45 Wh
Energy Density E _d ¹⁰	5.9 Wh/kg	6.3 Wh/kg
Usable Power DensityPd ¹¹	13 kW/kg	7.6 kW/kg
Matched Impedance Power Density P _{dMax} ¹² , 10 Hz ESR	27 kW/kg	15.8 kW/kg
Matched Impedance Power Density PdMax 12, 1 kHz ESR	35.7 kW/kg	22.3 kW/kg

THERMAL CHARACTERISTICS		
Туре	C35S-3R0-0330	C35S-3R0-0360
Working Temperature	-40 ~ 65°C	-40 ~ 65°C
Storage Temperature ¹³	-40 ~ 55°C	-40 ~ 55°C
Thermal Resistance R _{Th} ¹⁴	11.7 K/W	11.7 K/W
Thermal Capacitance C _{Th} ¹⁵	82 J/K	85 J/K

LIFETIME CHARACTERISTICS		
Туре	C35S-3R0-0330	C35S-3R0-0360
DC Life at High Temperature, 3V and $65^{\circ}C^{16}$	1500 hours	1500 hours
DC Life at RT ¹⁷	10 years	10 years
Cycle Life ¹⁸	1'000'000 cycles	1′000′000 cycles
Shelf Life ¹⁹	4 years	4 years

SAFETY & ENVIRONMENTAL SPECIFICATIONS				
Туре		C35S-3R0-0330	C35S-3R0-03	360
Safety		RoHS, REACH and UL81	0 RoHS, REACH	Hand UL810
Vibration		ISO 16750 table 12	ISO 16750 ta	ble 12
Shock		IEC 60068-2-27	IEC 60068-2-	27
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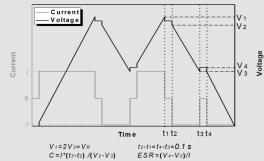


PHYSICAL PARAMETERS

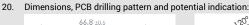
C35S-3R0-0330	C35S-3R0-0360
70 g	72 g
Solderable ²¹	Solderable ²¹
62.7 mm	62.7 mm
35.3 mm	35.3 mm
	70 g Solderable ²¹ 62.7 mm

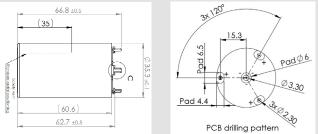
NOTES:

- 1. Surge voltage V_{S} : Absolute maximum voltage, non-repetitive. The duration must not exceed 1 second.
- 2. Capacitance C: The test current is 0.1 A/F, if the calculated current is >100A, then apply 100A.



- 3. Capacitance tolerance: Initially +10%~+30%.
- 4. Leakage current measurement procedure: 1) Charge the capacitor to the V_R with a constant current (0.1 A/F, if the calculated current is >100A, then apply 100A). 2) Hold the voltage at V_R for 72h. 3) The current to maintain V_R after 72 h is the leakage current.
- $\begin{array}{ll} \text{5.} & \text{Self-discharge rate measurement procedure: 1) Charge the} \\ & \text{capacitor to } V_{\text{R}} \text{ with a constant current (0.1 A/F, if the calculated} \\ & \text{current >100A, then apply 100A). 2) Hold the voltage at } V_{\text{R}} \text{ for 8h. 3)} \\ & \text{Floating for 72h. 4) Measure the voltage after 72 h.} \end{array}$
- 6. Max constant working current: $I_{MCC} = \sqrt{\Delta T / (ESR * R_{Th})}$
- 7. Max current: $I_{Max} = 0.5C * V_R / (\Delta t + ESR * C)$, discharge from V_R to V_R/2 in 1 second.
- 8. Short current: $I_5 = V_R / ESR$
- 9. Stored energy: $E = 0.5C * V^2/3600$
- 10. Energy density: $E_d = E/M$
- 11. Usable power density: $P_d = (0.12V_R^2/ESR)/M$
- 12. Matched impedance power density: $P_{dMax} = (0.25V_R^2/ESR)/M$
- 13. Storage temperature: Storage in discharge state
- 14. Thermal resistance: $R_{Th} = \Delta T / P$, where P = ESR * I²
- 15. Thermal capacitance: For the whole capacitor
- 16. DC life at high temperature: Hold the capacitor charged at specified voltage and temperature. The capacitance shall be >80% of the rated value, the ESR shall be <200% of the rated value.</p>
- DC life at RT: Hold the capacitor charged at rated voltage at room temperature RT, the capacitance shall be >80% of the rated value, the ESR shall be <200% of the rated value.
- 18. Cycle life: Charge and discharged the capacitor in the range between V_R and $V_R/2$. 5 seconds waiting period between charge and discharge. The constant test current is 0.1 A/F (if the calculated current >100A, then apply 100A).
- 19. Shelf life: Discharged and no load applied at RT.



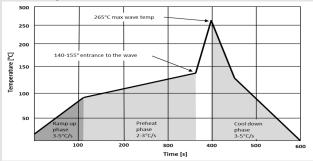


Standard markings:

- + Name of manufacturer, part number, serial number
- + Rated voltage and capacitance, positive terminals, warning marking
- + Stored energy in watt-hours

Mounting recommendations:

- + Mounting without applying undue mechanical stress on the terminals
- Provide adequate spacing in between cells to secure required insulation strength
 Provide clearance around the safety vent and do not position anything next to the safety vent that may be damaged in an event of vent rupture
- 21. Recommended wave soldering profile for printed circuit assembly with use of lead-free alloy:



Total soldering process time from room temperature to peak temperature 265°C and cool down is 10 minutes max. The time to reach the required temperatures depends on the design of the application and on the power of pre-heating section of the soldering machine. All temperatures are measured on the cell leads on top of the PCB. Recommended thickness for PCB = 2.4 to 3.2 mm.

Solder:	Lead-free (Sn96.5/Ag 3.0/Cu0.5) liquidus point 217°C
Recommended Flux	Kester 979T
Ramp Up Rate:	3°-5° C/sec. Max
Preheat:	140° to 155° C 2°-3° C/sec on top of board
Temperature entrance into v	vave: 140° to 155° C on top of board
Ramp to peak temp:	200°C/sec
Peak Temp:	265°C for 1.5 to 5 sec. Max
Cool Down Rate:	3°C-5°C /sec. Max
Conveyor Speed:	40-50 cm/min

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